## **ASMT-CB00** InGaN Blue, 0.4mm Low Profile Right Angle Surface Mount ChipLED

# Data Sheet

## Description

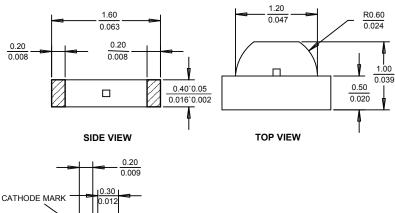
The ASMT-CB00 of blue color chip-type LEDs is designed with the smallest footprint to achieve high density of components on board. They have the industry standard footprint 1.6 mm x 1.0 mm and a height of only 0.4 mm. This makes them very suitable for cellular phone and mobile equipment backlighting and indication application where space is a constraint. In order to facilitate automated pick and place operation, these ChipLEDs are shipped in conductive tape and reel, with 4000 units per reel. These part are compatible with IR soldering.

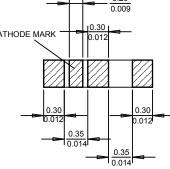
## Features

- Small size right angle mount
- 0603 industry standard footprint
- 0.4 mm low profile type
- Operating temperature range of -30°C to +85 °C
- Compatible with IR reflow soldering process
- Available in 8mm tape on 178mm (7') diameter reels
- Reel sealed in zip locked moisture barrier bags

## **Applications**

- LCD Backlighting
- Keypad Side / Backlighting
- Pushbutton backlighting
- Symbol Indicator





TERMINAL VIEW

Notes:

1. All dimensions will be in millimeters (inches)

2. Tolerance is  $\pm 0.1 \text{mm}$  ( $\pm 0.004$  in) unless otherwise stated

**CAUTION:** ASMT-CB00 LEDs are Class 1A ESD sensitive per JESD22-A114C.01. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

## Package Dimension



## **Device Selection Guide**

Package Dimension (mm)	Parts per Reel	Package Description
1.6 (L) x 1.0 (W) x 0.4 (H)	4000	Untinted, Non-diffused

## Absolute Maximum Ratings at $T_A=25^\circ C$

Parameter	ASMT-CB00	Unit	
DC Forward Current <sup>[1]</sup>	10	mA	
Power Dissipation	32	mW	
Reverse Voltage ( $I_R = 100 \mu A$ )	5	V	
LED Junction Temperature	95	°C	
Operating Temperature Range	-30 to +85	°C	
Storage Temperature Range	-40 to +85	°C	
Soldering Temperature	See reflow soldering profile (Figure 7 & 8)		

#### Note:

1. Derate linearly as shown in Figure 4.

## Electrical Characteristics at $T_A = 25^{\circ}C$

Forward Voltage V <sub>F</sub> (Volts) <sup>[1]</sup> @ I <sub>F</sub> = 5mA			Reverse Breakdown V <sub>R</sub> (Volts) @ I <sub>R</sub> = 100µA	Thermal Resistance R0 <sub>J-PIN</sub> (°C/W)
Part Number	Тур.	Max.	Min.	Тур.
ASMT-CB00	2.85	3.15	5	450

Notes:

1. Vf tolerance :  $\pm 0.1V$ 

## Optical Characteristics at $T_A=25^\circ C$

Luminous Intensity I <sub>V</sub> <sup>[1]</sup> (mcd) @ 5mA		Peak Wavelength $\lambda_{ extsf{peak}}$ (nm)	Dominant Wavelength $\lambda_{d}$ <sup>[2]</sup> (nm)	Viewing Angle 2 $\theta_{1/2}$ <sup>[3]</sup> (Degrees)	
Part Number	Min.	Тур.	Тур.	Тур.	Тур.
ASMT-CB00	7.2	18	469	473	150

Notes:

1. The luminous intensity I<sub>V</sub> is measured at the peak of the spatial radiation pattern which may not be aligned with the mechanical axis of the LED package.

2. The dominant wavelength,  $\lambda_d$ , is derived from the CIE Chromaticity Diagram and represents the perceived color of the device.

3.  $\theta_{1/2}$  is the off-axis angle where the luminous intensity is  $\frac{1}{2}$  the peak intensity.

	Intensity (mcd)	
Bin ID	Minimum	Maximum
К	7.20	11.20
L	11.20	18.00
М	18.00	28.50

Tolerance : ±15%

Notes:

1. Bin categories are established for classification of products. Products may not be available in all categories. Please contact your Avago representative for information on current available bins.

## **Color Bin Limits**

Dominant Wavelength (nm)		
Minimum	Maximum	
460.0	465.0	
465.0	470.0	
470.0	475.0	
475.0	480.0	
	Minimum   460.0   465.0   470.0	

Tolerance : ±1nm

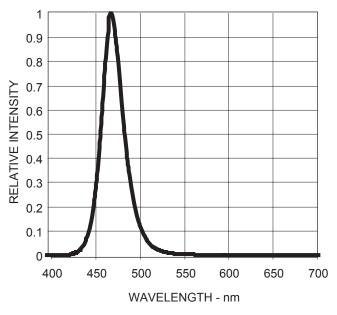


Figure 1. Relative intensity vs. wavelength

## Forward Voltage (V<sub>F</sub>) Bin Limits

	Forward Voltag	e (V)
Bin ID	Minimum	Maximum
1	2.55	2.75
2	2.75	2.95
3	2.95	3.15

Tolerance : ±0.1V

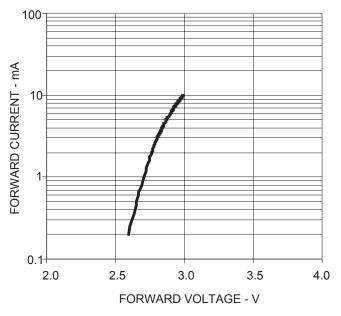


Figure 2. Forward current vs. forward voltage

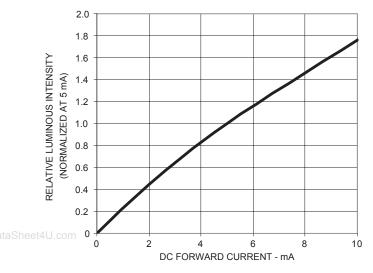


Figure 3. Luminous intensity vs. forward current

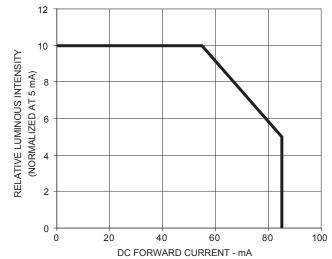


Figure 4. Maximum forward current vs. ambient temperature

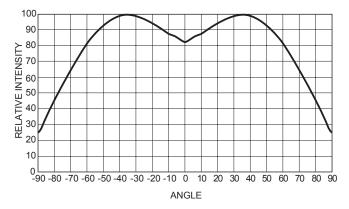


Figure 5. Radiation pattern

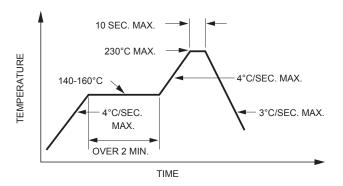
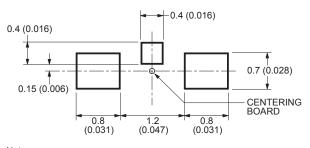


Figure 7. Recommended reflow soldering profile



Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is  $\pm 0.1$ mm ( $\pm 0.004$ in.) unless otherwise specified

Figure 6. Recommended soldering land pattern

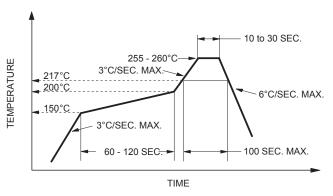
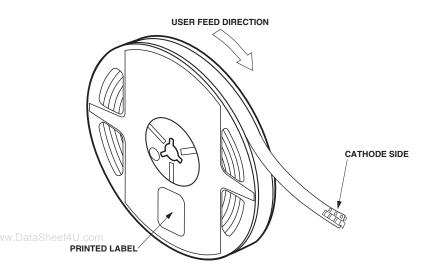
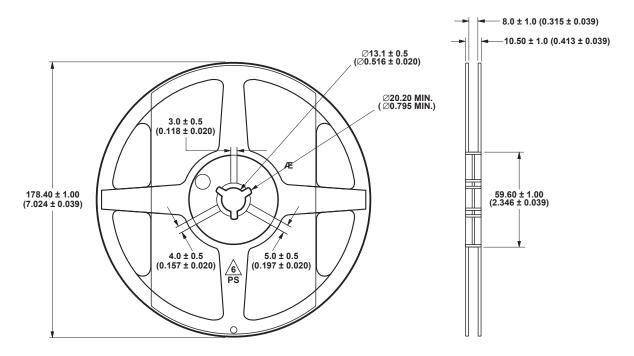


Figure 8. Recommended Pb-free reflow soldering profile



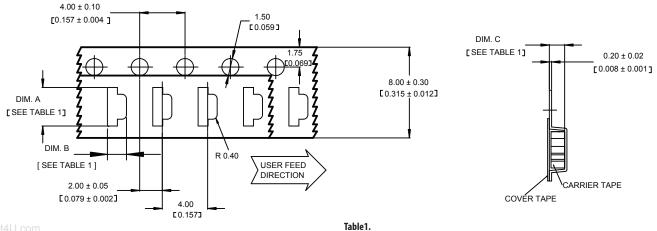




#### Figure 10. Reel dimensions

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1$  mm ( $\pm 0.004$  in.) unless otherwise specified.



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Notes:

1.

PART NUMBER	$\text{DIM.A}\pm0.10(0.004)$	DIM.B $\pm$ 0.10 (0.004)	$\text{DIM.C}\pm0.10~(0.004)$
ASMT-CA00	1.75 (0.069)	1.10 (0.043)	0.60 (0.024)
Dimensions In Mi	llimeters (Inches)		

Figure 11. Tape dimensions

All dimensions are in millimeters (inches).

2. Tolerance is ±0.1mm (±0.004in.) unless otherwise specified.

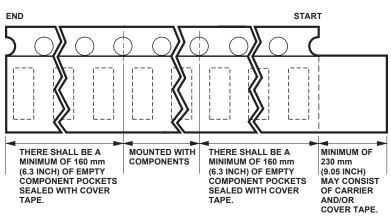


Figure 12. Tape leader and trailer dimensions

## **Reflow Soldering**

For more information on reflow soldering, refer to Application Note AN-1060, Surface Mounting SMT LED Indicator Components.

## **Storage Condition**

5 to 30°C @ 60%RH max.Baking is required before mounting, if

- 1. Humidity Indicator Card is > 10% when read at  $23 \pm 5^{\circ}$ C.
- 2. Device expose to factory conditions <30°C/60%RH more than 672 hours.

Recommended baking condition: 60±5°C for 20 hours.

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For product information and a complete list of distributors, please go to our web site: www.avagotech.com

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